IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

James M. Derderian

Serial No.: 10/770,890

Filed: February 2, 2004

FOR: METHODS FOR FORMING ASSEMBLIES AND PACKAGES THAT INCLUDE STACKED SEMICONDUCTOR DEVICES SEPARATED A DISTANCE DEFINED BY ADHESIVE MATERIAL INTERPOSED THEREBETWEEN

Confirmation No.: 1094

Examiner: L. Thai

Group Art Unit: 2891

Attorney Docket No.: 2269-4817.3US

(01-0103.03/US)

Notice of Allowance Mailed:

September 14, 2007

VIA ELECTRONIC FILING

DECEMBER 12, 2007

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

Mail Stop ISSUE FEE Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

These Comments follow the Notice of Allowance of September 14, 2007, which was accompanied by an Examiner's Statement of Allowable Subject Matter, and are being filed pursuant to 37 C.F.R. § 1.104(e).

The Examiner's Statement of Allowable Subject Matter provides:

Regarding independent claims 1 and 16, the primary reason for the allowance of the claims is based on the arguments presented by the applicant at pages 8-13 of the Remarks of the amendment filed on 7/10/07.

Since each of claims 2-15 and 17-33, directly or indirectly, depends either on claims 1 or claim 16, they are also allowed.

The scope of each claim is based on its actual language and equivalents thereto. The record of the prosecution of the above-referenced application as a whole makes clear the reasons that the allowed claims are patentable.

Respectfully submitted,

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Date: December 12, 2007

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